TOSHIBA Insulated Gate Bipolar Transistor Silicon N Channel IGBT

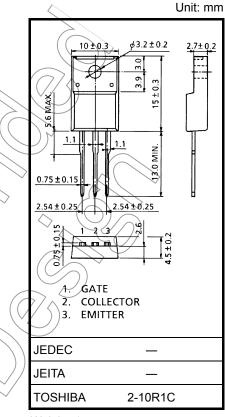
GT15J321

High Power Switching Applications Fast Switching Applications

- Fourth-generation IGBT
- Fast switching (FS
- Enhancement mode type
- High speed: $t_f = 0.03 \,\mu s$ (typ.)
- Low saturation Voltage: VCE (sat) = 1.90 V (typ.)
- FRD included between emitter and collector

Absolute Maximum Ratings (Ta = 25°C)

			•	\setminus \langle $//$	
Characteristics		Symbol	Rating	Unit	
Collector-emitter voltage		V _{CES}	600	v	
Gate-emitter voltage		V _{GES}	±20		
Collector current	DC	IC	15	A	
	1 ms	I _{CP}	30,		
Emitter-collector forward current	DC	l _F	15	A	
	1 ms	IFM	30		
Collector power dissipation (Tc = 25°C)	l	PC	30	w	
Junction temperature		(Jj.))	150	∑°¢	
Storage temperature range		7) (Tstg	-55~150	\rightarrow \cdot	
		/ /)]		.)	

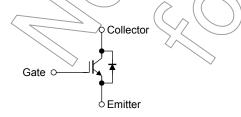


Weight: 1.7 g

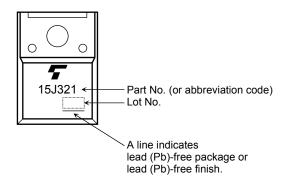
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Equivalent Circuit



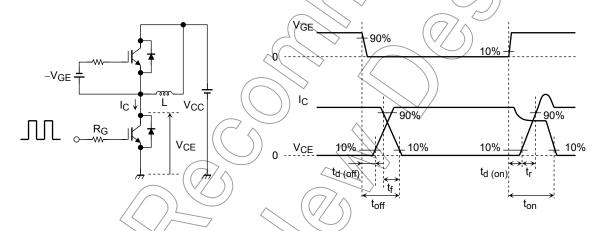
Marking



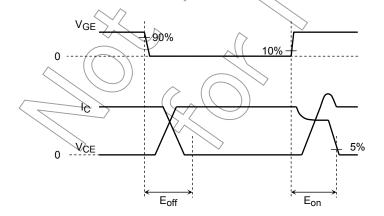
Electrical Characteristics (Ta = 25°C)

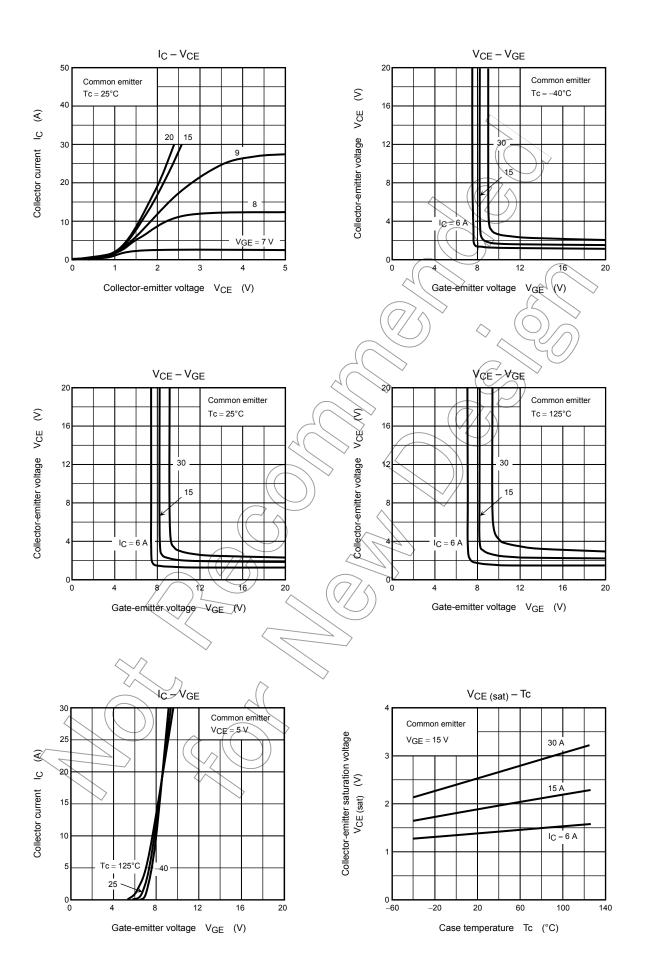
Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GES}	$V_{GE} = \pm 20 \text{ V}, V_{CE} = 0$	_	_	±500	nA
Collector cut-off of	current	I _{CES}	V _{CE} = 600 V, V _{GE} = 0	_	_	1.0	mA
Gate-emitter cut-	off voltage	V _{GE} (OFF)	I _C = 1.5 mA, V _{CE} = 5 V	3.5	_	6.5	V
Collector-emitter	saturation voltage	V _{CE} (sat)	I _C = 15 A, V _{GE} = 15 V		1.90	2.45	V
Input capacitance	9	C _{ies}	V _{CE} = 20 V, V _{GE} = 0, f = 1 MHz	F	2300	_	pF
Switching time Turn-o Fall tim	Rise time	t _r	Inductive Load $V_{CC}=300 \text{ V, } I_{C}=15 \text{ A}$ $V_{GG}=15 \text{ V, } R_{G}=43 \Omega$ (Note 1)	<u> </u>	0.04	_	μs
	Turn-on time	t _{on}		<i>)</i>	0.17	_	
	Fall time	t _f		, —	0.03	0.15	
	Turn-off time	t _{off}		_	0.34	_	
Peak forward volt	tage	V _F	I _F = 15 A, V _{GE} = 0		4	2,0	٧
Reverse recovery	y time	t _{rr}	$I_F = 15 \text{ A, di/dt} = -100 \text{ A/}\mu\text{s}$	- /	7	200	ns
Thermal resistance	ce (IGBT)	R _{th (j-c)}	$(\forall /)$	-((4.16	°C/W
Thermal resistant	ce (Diode)	R _{th (j-c)}		4	4	4.63	°C/W

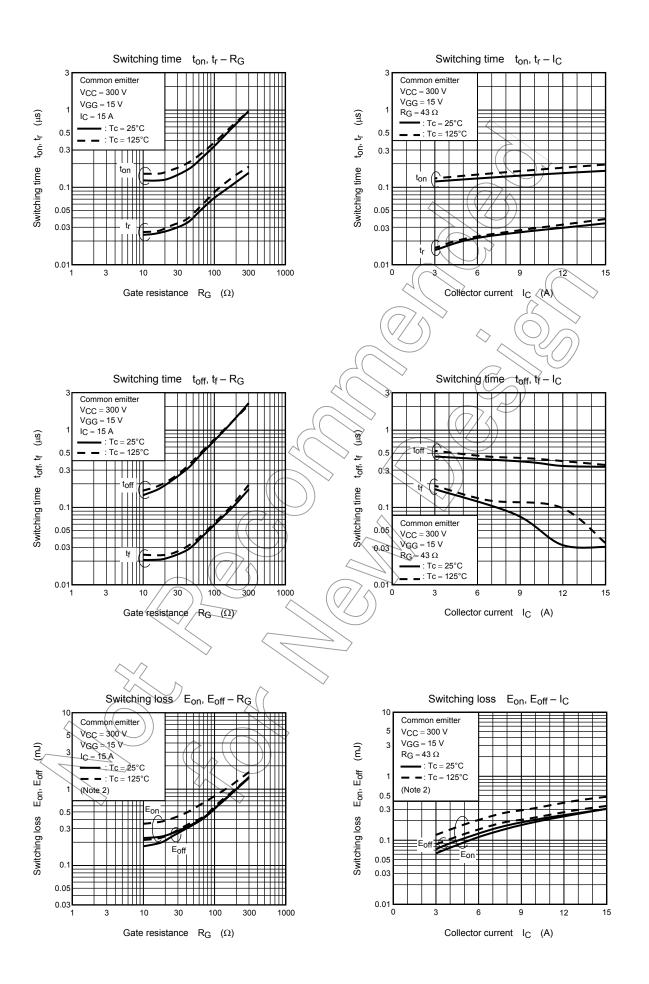
Note 1: Switching time measurement circuit and input/output waveforms



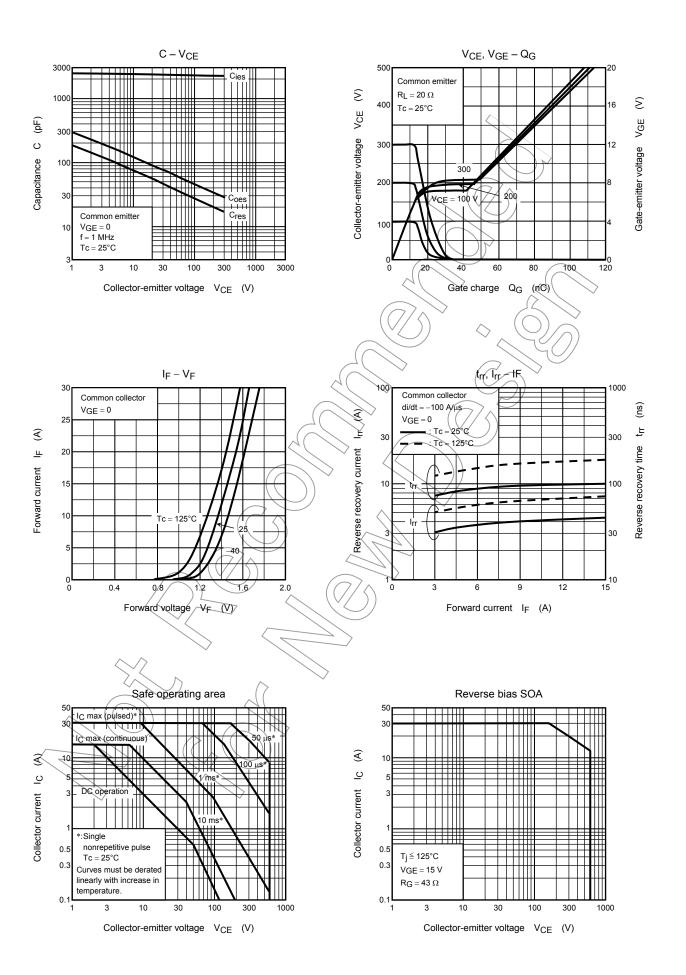
Note 2: Switching loss measurement waveforms

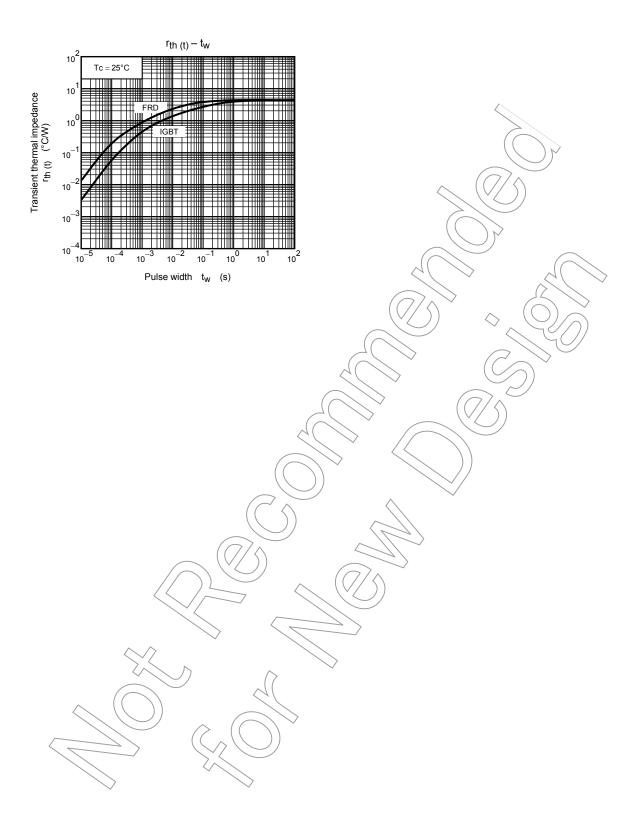






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